| ABBOCIATION CONNECTING<br>ELECTRONICS (NOUSTRIES IN CONNECTING<br>ELECTRONICS (NOUSTRIES IN CONNECTING)<br>International and Pan-American co | burn. Illinois. All rights reserved | under both This docu      | ument is a declarati<br>s, the declaration e | on of the substance<br>ncompasses all low | es within the manufactur<br>wer level materials for wl | er listed item. Note: i<br>hich the manufacture | f the item is an as<br>r has engineering | ssembly with lower responsibility. |  |
|--|-------------------------------------|---------------------------|--|---|--|---|--|------------------------------------|--|
| IPC Web Site for Information on I   http://www.ipc.org/IPC-175x  | IPC-1752 Standard                   | Form Type *<br>Distribute |  | laration Class *<br>ss 6 - RoHS Yes/N     | o, Homogeneous Materi                                  | als and Mfg Informat                            | s and Mfg Information                    |                                    |  |
| Supplier Information   |                                     |                           |  |   |  |   |  |                                    |  |
| Company name*  | name* Company unique ID             |                           | Unique ID Authority                          |   |  | Response Date*                                  |  |                                    |  |
| onsemi   |                                     |                           |  |   |  | 2025-06-08                                      |  |                                    |  |
| Contact Name   | Title - Contact                     |                           | Phone - Contact*                             |   |  | Email - Contact*                                |  |                                    |  |
| Product-Env-Stewards   | Product Enviro Compliance           |                           | NA   |   |  | Product-Env-Stewards@onsemi.com                 |  |                                    |  |
| Authorized Representative*   | Title - Representative              |                           | Phone - Representative*                      |   |  | Email - Representative*                         |  |                                    |  |
| Product-Env-Stewards Product Enviro Con  |                                     | Compliance                |  | NA  |  |   | Product-Env-Stewards@onsemi.com          |                                    |  |
| Requester Item Number Mfr Iten   | n Number Mfr Item Name              | Mfr Item Name             |  | Version                                   | Manufacturing Site                                     | Weight*   | UOM                                      | Unit Type                          |  |
| FDMS8  | 6500DC FET 60V 2.3 mC               | 0hm PQFN56                | 2025-06-08                                   | 5-06-08 PBB                               |  | 121.5064  | mg                                       | Each                               |  |
| Manufacturing Proccess Information   |                                     |                           |  |   |  |   | · · ·                                    |                                    |  |
| Terminal Plating / Grid Array Material   | Ferminal Base Alloy                 | J-STD-020 MSL Rating      | Peak Proce                                   | ess Body Tempera                          | ture Max Time at Peak                                  | Temperature Numb                                | nperature Number of Reflow Cycles        |                                    |  |
| Matte Tin (Sn) - annealed CU Alloy 1   |                                     | 1                         | 260  | С   | 30   | seconds 3                                       |  |                                    |  |
| Comments   |                                     |                           |  |   |  |   |  |                                    |  |
| level 1 - maximum time at peak temperature during so   | ldering is 10-30 seconds            |                           |  |   |  |   |  |                                    |  |
| For more information regarding material composition  | please refer to page 3              |                           |  |   |  |   |  |                                    |  |

| RoHS Material Composition Declaration  |   |  |   | Declaration Type *  | Detailed  |
|--|---|--|---|---|---|
| Directive 2015/863/EU amending RoHS<br>Directive 2011/65/EU  |   | mium (Cr6+), Polybrominated Biphenyls (Pl  |   | dmium and quantity limit of 0.1% by mass (10<br>minated Diphenyl Ethers (PBDE), and Bis(2-et  |   |
| cadmium, hexavalentchromium, polybromina<br>contains a RoHS restricted substance inexces<br>encompass all such components. Supplier cer<br>as of the date that Supplier completes this for<br>Company acknowledges that Supplier may h<br>independently verified information provided<br>certification in this paragraph. If the Company | ated biphenyls and/or polybrominated dip<br>s of an applicable quantity limit, please in<br>ifies that it gathered the information it pr<br>m.Supplier acknowledges that Company<br>ave relied on informationprovided by oth<br>by others, Supplier agrees that, at a minir<br>and the Supplier enter into a written agr<br>esource of the Supplier's liability and the | henyl ethers (each a "RoHS restricted substa<br>ndicate below which, if any, RoHS exemption<br>ovides in this form using appropriate methoo<br>will rely on this certification in determining<br>ers in completing this form, and that Supplie<br>num, itssuppliers have provided certification<br>eement with respect to the identified part, the<br>Company's remedies for issues that arise reg | nce") in exco<br>n you believe<br>ls to ensure i<br>the compliar<br>r may not ha<br>s regarding t<br>terms and co | e may apply. If the part is an assembly with low<br>s accuracy and that such information is true an<br>ce of its products with European Union member<br>de independently verified such information. Ho<br>neir contributions to the part, and those certifica | ove. If a homogeneous material within the part<br>er level components, the declaration shall<br>d correct to the best of its knowledge and belief,<br>er state laws that implement the RoHS Directive.<br>wever, in situations where Supplier has not<br>ations are at least as comprehensive as the<br>anty rights and/or remedies provided as part of |
| RoHS Declaration * 4 - Item(   | s) does not contain RoHS restricted subst   | ances per the definition above except for sele   | ected exempt  | ions Supplier Acceptance  | * Accepted  |
| Exemption: 7a: Lead in high melting temp   | erature type solders (i.e. lead based sol   | der alloys containing 85% by weight or m   | ore lead).  |   |   |
| Exemption List Version   | EL-2011/534/EU  |  |   |   |   |
| Declaration Signature  |   |  |   |   |   |
| Instructions: Complete all of the required<br>Requester) and click on Submit Form to h   |   |  | e drop-dowi   | a. This will display the signature area. Digita   | lly sign the declaration (if required by the  |
| Supplier Digital Signature   | astislav Drska  | Le   |   |   |   |

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

| Homogeneous Material | Weight | Unit of Measure | Level    | Substance           | CAS              | Exempt | Weight  | Unit of Measure |
|----------------------|--------|-----------------|----------|---------------------|------------------|--------|---------|-----------------|
| Clip                 | 19.1   | mg              | Supplier | Zinc (Zn)           | 7440-66-6        |        | 0.0229  | mg              |
|                      |        |                 | Supplier | Iron (Fe)           | 7439-89-6        |        | 0.4489  | mg              |
|                      |        |                 | Supplier | Copper (Cu)         | 7440-50-8        |        | 18.6225 | mg              |
|                      |        |                 | Supplier | Phosphorus (P)      | 7723-14-0        |        | 0.0057  | mg              |
| Die                  | 2.54   | mg              | Supplier | Silicon (Si)        | 7440-21-3        |        | 2.54    | mg              |
| Die Attach Solder    | 3.021  | mg              | Supplier | Silver (Ag)         | 7440-22-4        |        | 0.0755  | mg              |
|                      |        |                 | А        | Lead (Pb)           | 7439-92-1        | 7a     | 2.7944  | mg              |
|                      |        |                 | Supplier | Tin (Sn)            | 7440-31-5        |        | 0.151   | mg              |
| Lead Frame           | 45.8   | mg              | Supplier | Silver (Ag)         | 7440-22-4        |        | 0.1374  | mg              |
|                      |        |                 | Supplier | Zinc (Zn)           | 7440-66-6        |        | 0.055   | mg              |
|                      |        |                 | Supplier | Iron (Fe)           | 7439-89-6        |        | 1.0763  | mg              |
|                      |        |                 | Supplier | Copper (Cu)         | 7440-50-8        |        | 44.5176 | mg              |
|                      |        |                 | Supplier | Phosphorus (P)      | 7723-14-0        |        | 0.0137  | mg              |
| Mold Compound-Black  | 42.715 | mg              |          | Epoxy resin         | proprietary data |        | 5.6811  | mg              |
|                      |        |                 | Supplier | Carbon Black (C)    | 1333-86-4        |        | 0.0854  | mg              |
|                      |        |                 | Supplier | Fused Silica (SiO2) | 60676-86-0       |        | 36.9485 | mg              |
| Plating              | 8.33   | mg              | Supplier | Tin (Sn)            | 7440-31-5        |        | 8.33    | mg              |
| Wire Bond - Cu       | 4.0E-4 | mg              | Supplier | Copper (Cu)         | 7440-50-8        |        | 0.0004  | mg              |